II. CLAIM AMENDMENTS

1. (Currently amended) A system for providing data communication between a plurality of electronic modules connected to an I^2C^{TM} -bus, wherein the system comprises said plurality of electronic modules and said I^2C^{TM} -bus; and wherein each of said plurality of electronic modules are adapted to communicate communicates, via said I^2C^{TM} -bus, a data package comprising:

in-a layered structure <u>having</u> a physical layer complying with I²CTM specifications, a data link layer comprising first header field for data payload type and a second header field for a data link layer version, and a network/transport layer comprising a third header field for a-transmitting <u>an</u> electronic module's address, a fourth header field for a length of said data package, and comprising <u>a</u> data payload, <u>and</u>

wherein information contained within said header fields provides compatibility among individual ones of said electronic modules operating under differing rules of data exchange.

- 2. (Currently amended) A system according to claim 1, wherein said electronic modules comprise a mobile communication device <u>consisting of such as</u> a cell, mobile or satellite telephone, a personal digital assistant, or peripherals thereto.
- 3. (Original) A system according to claim 1, wherein said data payload type comprises OBEX, TCP, IP, HTTP, or any proprietary payload type.

- 4. (Original) A system according to claim 1, wherein said data link layer version comprises a major version, which is binary incompatible, and a minor version, which is binary compatible.
- 5. (Original) A system according to claim 1, wherein said data package further comprises in said network/transport layer a fifth header field for an offset value for determination of data payload start in said data package.
- 6. (Currently amended) A system according to claim 1, wherein said data package further comprises in said network/transport layer a sixth header field, located prior to said data payload start in said data package, for buffering the data payload from other ones of the header fields.
- 7. (Original) A system according to claim 1, wherein said data package further comprises a checksum field following the data payload.
- 8. (Original) A system according to claim 1, wherein said data package further comprises in said network/transport layer a seventh header field for a data package number.
- 9. (Original) A system according to claim 1, wherein said data package further comprises in said network/transport layer an eighth header field for a data package fragment sequence number.

- 10. (Currently amended) A <u>method for formulating a</u> data package for communicating between a plurality of electronic modules connected to an I^2C^{TM} -bus, wherein said data <u>package</u>-comprising:
 - <u>providing the data package with in-</u>a layered structure <u>having physical layer data</u> complying with I²CTM specifications,
 - <u>placing</u> data link layer data in a first header field comprising data payload type, and in<u>serting</u> a second header field comprising a data link layer version,
 - <u>placing and</u> network/transport layer data in a third header field comprising a transmitting electronic module's address, in<u>serting</u> a fourth header field comprising a length of said data package, and comprising providing a data payload, and
 - wherein information contained within said header fields provides compatibility among individual ones of said electronic modules operating under differing rules of data exchange.
- 11. (Currently amended) A <u>method of formulating a data package according to claim 10</u> further comprising <u>inserting in said network/transport layer a fifth header field for an offset value for determination of data payload start in said data package.</u>

- 12. (Currently amended) A <u>method of formulating a data package according to claim</u>
 10, <u>wherein_including a making of said data payload of a type comprises comprising</u>
 OBEX, TCP, IP, HTTP, or any proprietary payload type.
- 13. (Currently amended) A <u>method of formulating a data package according to claim 10</u> further comprising <u>inserting</u> in said network/transport layer a sixth header field, at a <u>location</u> prior to said data payload start in said data package, for buffering the <u>data payload from other ones of the header fields</u>.
- 14. (Currently amended) A <u>method of formulating a data package according to claim 10</u> further comprising inserting a checksum field following the data payload.
- 15. (Currently amended) A <u>method of formulating a data package according to claim 10</u> further comprising <u>inserting in said network/transport layer a seventh header field for a data package number.</u>
- 16. (Currently amended) A <u>method of formulating a data package according to claim 10</u> further comprising <u>inserting in said network/transport layer an eighth header field for a data package fragment sequence number.</u>
- 17. (Currently amended) A receiver unit adapted to receive-for receiving a data package formulated according to claim 10, wherein the receiver unit comprises at least one module of a plurality of electronic modules and a I²CTM-bus that interconnects the

modules of said plurality of electronic modules, and wherein each of said plurality of electronic modules communicates via said I^2C^{TM} -bus.

- 18. (Currently amended) A transmitter unit adapted to transmit for transmitting a data package formulated according to claim 10, wherein the transmitter unit comprises at least one module of a plurality of electronic modules and a I^2C^{TM} -bus that interconnects the modules of said plurality of electronic modules, and wherein each of said plurality of electronic modules communicates via said I^2C^{TM} -bus.
- 19. (Currently amended) A method for establishing data communication between a plurality of electronic modules connected to an I^2C^{TM} -bus, wherein said plurality of electronic modules each communicate a data package comprising in-a layered structure <u>having</u> a physical layer complying with I^2C^{TM} -bus specifications, and wherein said method comprising comprises:
 - providing in said data package, in a data link layer, a first header field for data payload type and a second header field for a data link layer version,
 - providing in said data package, in a network/transport layer, a third header field for a transmitting electronic module's address and a fourth header field for a length of said data package, and
 - providing in said data package a data payload for establishing data communication between a plurality of said electronic modules, and
 - wherein information contained within said header fields provides compatibility among individual ones of said electronic modules operating under differing rules of data exchange.

- 20. (Currently amended) A <u>server of a computer program, wherein the computer program comprising comprises</u> code adapted to perform performing the following steps when said program is run in a data processor adapted to establish data communication between a plurality of electronic modules connected to an I^2C^{TM} -bus, wherein said plurality of electronic modules each communicate a data package comprising:
 - in—a layered structure having a physical layer complying with I²C[™] specifications, and wherein said program providing—provides in said data package in a data link layer a first header field for data payload type and a second header field for a data link layer version, providing—provides in said data package in a network/transport layer a third header field for a transmitting electronic module's address and a fourth header field for a length of said data package, and providing—provides in said data package a data payload, and
 - wherein information contained within said header fields provides compatibility among individual ones of said electronic modules operating under differing rules of data exchange.